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No. SW064660A

Date: 2006 - 06 - 16

SPECIFICATION

ALPS';

MODEL: SPUJ195500

Spec. No.: SPUJ-S-501

Sample No.: F3216728M



DSG. D H. Gamaguchi

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ENG. DEPT. DIVISION

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SPUJ-S-501 SPUJ PRODUCT SPECIFICATIONS 1. General 1.1 Application This specification is applied to low current circuit (Secondary circuit) push switch used for electronic equipment. 1.2 Operating temperature range: -10 ~ 60°C & Storage temperature range -10 ~60°C

1.3 Test conditions The standard test conditions shall be 5~35°C in temperature, 45~85% RH and 86~106kPa (860~1060mbar) In atmospheric pressure. Should any doubt arise in judgement, tests shall be conducted at 20±2°C, 65±5% RH and 86~106kPa 4860~1060mbar} 2. Appearance, construction and dimensions 2.1 Appearance Switch shall have good finishing, and shall have no rust, crack or plating failures. 2.2 Construction and dimensions Per individual product drawing .2.3 Markings Per individual product drawing
3. Rating 30 V DC 0.1 A (Resistive load) 3. Rating 4. Electrical performance Test conditions Items Criterion Shall be measured at 1kHz ± 200Hz (20mV MAX , 50mA MAX) or 1A, 5V DC Contact resistance by voltage drop method.

Test voltage: 500 V DC, measured after 1 minute±5 seconds. Insulation 100 HQ HIN resistance Applied position : Between all terminals Between terminals and ground (frame) Voltage proof Test voltage: 500 V AC (50~60Hz, cut-off current 2 mA) No dielectric breakdown shall occur. Applied position : Between all terminals Between terminals and ground (frame) Capacitance Shall be measured at 1MHz ± 10kHz 1.5 pF HAX Between all terminals Between terminals and ground (frame) Between all circuits Changeover timing As per individual product drawing. 5. Mechanical performance Items Test conditions Criterion Operating force A static load shall be applied to the tip of actuator in operating As per individual product drawing. direction. 5.2 5 N + 510 gfl shall be applied to the tip of Terminal strength A static load of Shall be free from terminal looseness terminal in a desired direction for 1 minute. The number of test shall and damage and breakage of terminal be once per terminal. holding portion. Terminals may be bent after test, electrical performance requirement specified in item 4 shall be satisfied. Hounting strength Thread shall be mounted at __O.6 N·m 16.12 kgf-cm//by normal Shall be free from damage of thread portion. (Applied to frame with screw.) of thread portion mounting method. (1) A static load of 50 N = 5-1-kgf/Mshall be applied in the 5.4 Control strength Shall be free from pronounced wobble operating direction of actuator for 15 seconds.

(2) A static load of 50N 51 kg Nshall be applied in the 5.4.1 Control and mechanical abnormalities. strength pull direction of actuator for 15 seconds. (For construction with lock, the test shall be conducted at the condition of lock released.) (3) A static load of 10 HO2 her Ashall be applied to the vertical direction of operation at the tip of actuator for 15 seconds. (1) A static load of 10 N 10 2 kxfl Apall be applied in the pull 5.4.2 Lock hold-Lock shall not be dislocated. ing strength of Shall be free from pronounced wobble direction at the condition of locking actuator. actuator and abnormalities in operation. (Applied to the switch with lock mechanism) 5.5 Wobble of actuator Run-out(P-P) shall be measured by applying a static load of 1N (102gF) (P-P: O.8 nm MAX in the vertical direction of operation at the tip of actuator. (1.8 mm MAX, without frame.) 5.6 Row of actuator Switch shall be mounted as shown. Difference of sides shall be Difference between actuators (Applied to measured. $t_1 = \text{Within } 0.5 \text{ mm}$ multipul-key Maximum difference of actuator push switch) t₂ = Within <u>O.8</u> mm Difference between mounting hole and actuator ts = Within 0.5 mm Hole for mounting frame DSGD. TITLE '/s <u>A \ Nw.1.'02 F Y F Y M.H</u>
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T	Items	Test conditions	Criterion
.7	Hounting frame	Both ends of mounting frame shall be secured. A static load of	Varp on mounting frame shall be 0.
.	strength	30N +306kx17/shall be applied to the center of mounting frame	max. Shall be free from abnormalit
	(Applied to multi-	in A, B, C and D directions each 15 seconds.	in operation.
	pul-key push		
	switch)	C	
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8	Vibration	Switch shall be secured to a testing machine by a regular mounting	Contact resistance (Item 4.1) :
٦	t ini defail	device and method.	20 mQ MAX
		(1) Vibration frequency range: 10~55Hz	Insulation resistance (Item 4.2) :
		(2) Total amplitude: 1.5mm	100 HQ HIH
: [(3) Sweep ratio : 10-55-10(Hz) Approx. 1 minute	Voltage proof (Item 4.3) :
.	. • Carlos and I	(4) Method of changing the sweep vibration frequency : Logarithmic or	Apply 500 V AC for 1 minute.
		linear	No dielectric breakdown shall oc
		(5) Direction of vibration : Three vertical directions	Operating force (Item 5.1) :
		including actuator.	Within ±10 % of specified value
		(6) Time : 2 hours each (6 hours in total)	No abnormalities shall be recognize
		•	in appearance and construction.
9	Mechanical shock	Switch shall be measured after following test.	Contact resistance (Item 4.1) :
	5.9.1 Hechanical	(1) Hounting method: Hormal mounting method	20 mQ HAX
	shock .	(2) Acceleration : 490m/s ² (506)	Operating force (Item 5.1)
		(3) Duration: 11ms	Within ±36 % of specified val
		(4) Test direction: 6 directions	Shall be free from mechanical
		/m\	abnormalities.
		(5) Humber of shock : 3 times per direction	(Dislocation of lock of actuator s not be regarded as abnormalities.
F	5.9.2 Lock holding	(18 times in total) Switch shall be conducted at the condition of locking actuator.	Lock of actuator shall not be dis-
	shock	(1) Acceleration: 147m/s ² 156	located. Shall be free from
	(Applied to the	(2) Duration: 11 ms	abnormalities in operation.
1	switch with lock		
	mechanism.)	A) 1535 HILEGOIDH . O HILEGOIDHS	
	meciigii (Dili .)	(4) Humber of shock : 3 times per direction	·
		(18 times in total)	
10	Solderability	Switch shall be checked after following test.	Hore than 90% of immersed part sha
		(1) Solder: H63A (JIS Z 3282)	be covered with solder.
		(2) Flux: Rosin flux (JIS K 5902) having a nominal composition of 25%	
		solids by weight of water white rosin in methyl alcohol	
		(JIS K 1501) solution.	••
		(3) Soldering temperature : 230±5℃	
		Immersing time : 3±0.5 s	•
		Flux immersing time shall be 5~10 seconds in normal temperature.	-
		(4) Immersion depth: Immersion depth shall be at copper plating	
-		portion for P.C.B. terminal after mounting.	·
		Thickness of P.C. board: 1.6 mm	
,	C-1J	Cuitab aball be recovered office full eview test	No abnormalities shall be recognize
	Soldering heat resistance	Switch shall be measured after following test. (1) Solder: H63A (JIS Z 3282)	in appearance. The electrical perfe
- [1	1 69 19 railC6	(1) Solder · nosh (dis 2 5262) (2) Flux : Rosin flux (JIS K 5902) having a nominal composition of 10%	ance requirements specified in item
		solids by weight of water white rosin in methyl alcohol	shall be satisfied.
1			
		Lank (50) Solution	Ī
		(JIS K 1501) solution.	
		(3) Temperature and immersing time	
		(3) Temperature and immersing time Temperature (C) Time (s)	
•		(3) Temperature and immersing time Temperature (°C) Time (s) Dip soldering 260±5 5±1	
		(3) Temperature and immersing time Temperature (C) Time (s)	
		(3) Temperature and immersing time Temperature (°C) Time (s)	7777 F
		(3) Temperature and immersing time Temperature (°C) Time (s)	•
		(3) Temperature and immersing time Temperature (°C) Time (s)	

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<u> </u>	YUJ -S-501	SPUJ PRODUCT SPECIFICATIONS	
			<u> </u>
	Items	Test conditions	Criterion
		(4) Immersion depth: Immersion depth shall be at copper plating portion for P.C.B. terminal after mounting.	·
		Thickness of P.C. board (Single sided copper	
		clad P.C.B.) : 1.6mm	
		C100 1 • O • D • / - 1 • O • E	
12	Resistance to flux	Switch shall be checked after following test.	Flux shall not be risen up to cont
	(Applied to the	(1) Equipment : Auto-dip chamber	Shall be free from abnormalities i
	switch for P.C.	(2) Solder: H63A (JIS Z 3282)	operation.
	board)	(3) Flux: Rosin flux (JIS K 5902) having a nominal composition of 25%	
		solids by weight of water white rosin in methyl elcohol (JIS K 1501) solution.	
		(4) Temperature: 260±5°C	
	· .	(5) Immersing time: 5±1 s	
		(6) Immersion depth : Immersion depth shall be at copper plating	
	-	portion for P.C.B. terminal after mounting.	
		Thickness of P.C. board: 1.6 mm	
. Di	urability		
	Items	Test conditions	Criterion
	Operating life	Switch shall be operated 10,000 cycles at 15-20 cycles/minute without	Contact resistance (Item 4.1) :
-	without load	load.	40 mQ RAX
-	•		Insulation resistance (Item 4.2):
			10 MO MIN Voltage proof (Item 4.3):
			Apply 500 V AC for 1 minute.
			No dielectric breakdown shall oc
			Operating force (Item 5.1) :
	Land Control of		Within ±30 % of specified value
			No abnormalities shall be recognize
\perp			in appearance and construction.
2	Operating life	Switch shall be operated 10,000 cycles at 15~20 cycles/minute with	Contact resistance (Item 4.1):
	with load	30 V DC 0.1 A. (Resistive load)	40 mQ MAX
ĺ			Insulation resistance (Item 4.2):
-		·	Voltage proof (Item 4.3):
-			Apply 500 V AC for 1 minute.
			No dielectric breakdown shall oc
.	•		Operating force (Item 5.1):
.			Within ±18 % of specified value
			No abnormalities shall be recognize
			in appearance and construction.
Ve	eather proof		•
_	Items	-Test conditions	Criterion
	Cold proof	After testing at -20±2°C for 96 hours, the switch shall be allowed to	Contact resistance (Item 4.1) :
		stand under normal temperature and humidity conditions for 1 hour, and then measurement shall be made within 1 hour.	40 mQ MAX Insulation resistance (Item 4.2):
		Vater drops shall be removed.	10 NO KIN
1			Voltage proof (Item 4.3):
-			Apply 500 V AC for 1 minute.
			No dielectric breakdown shall occ
			Operating force (Item 5.1):
			Within ±30 % of specified value
			No abnormalities shall be recognized in appearance and construction.
1	Dry heat	After testing at 85±2°C for 96 hours, the switch shall be allowed to	Contact resistance (Item 4.1):
	a seem a	stand under normal temperature and humidity conditions for 1 hour, and	40 mQ MAX
		then measurement shall be made within 1 hour.	Insulation resistance (Item 4.2) :
-[<u>10</u> μΩ μΙΝ
	~		Voltage proof (Item 4.3):
		•	Apply 500 V AC for 1 minute.
			No dielectric breakdown shall occ
		•	Operating force (Item 5.1):
			Within ±38 % of specified values observed it is specified values.
- -			No abnormalities shall be recognized in appearance and construction.
			in appearance and construction.
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SPUJ PRODUCT SPECIFICATIONS SPUJ-S-501 Test conditions Criterion Items After testing at 40±2°C and 90~95%RH for 96 hours, the switch shall Contact resistance (Item 4.1) : 7.3 Damp heat 40 mΩ HAX be allowed to stand under normal temperature and humidity conditions for 1 hour, and measurement shall be made within 1 hour after that. Insulation resistance (Item 4.2): 10 HQ HIN Water drops shall be removed. Voltage proof (Item 4.3): Apply 500 V AC for 1 minute. No dielectric breakdown shall occur. Operating force (Item 5.1): Within $\pm \frac{1}{30}$ % of specified value. No abnormalities shall be recognized in appearance and construction. Salt mist Switch shall be checked after following test. No remarkable corrosion shall be (1) Temperature : 35±2℃ recognized in metal part. (2) Salt solution: 5±1% (Solids by weight) (3) Duration : 24±1 h After the test, salt deposit shall be removed in running water. Contact resistance (Item 4.1) : After 5 cycles of following conditions, the switch shall be allowed to 7.5 Temperature _40 mΩ HAX stand under normal temperature and humidity conditions for 1 hour, and cycling Insulation resistance (Item 4.2) : measurement shall be made within 1 hour after that. 10 HQ HIH Water drops shall be removed. Voltage proof (Item 4.3):
Apply 500 V AC for 1 minute. 70±2℃ -----No dielectric breakdown shall occur. Operating force (Item 5.1) : Within $\pm \frac{1}{30}$ % of specified value. No abnormalities shall be recognized Normal in appearance and construction. temperature -25±3℃ -----30 30 min min 10~15 10~15 min nin 1 cycle Insulation resistance (50V DC): DC voltage 1.5 times as much as rated voltage shall be applied 7.6 Damp heat with continuously between adjacent terminal at 60±2°C and 90~95%RH. After 10 MΩ min. load Voltage proof : Apply 100V AC for 1 (Silver migration) 500 hours testing, switch shall be allowed to stand under normal minute. No dielectric temperature and humidity condition for 1 hour, and measurement shall breakdown shall occur. be made within 1 hour after that. Water drops shall be removed. 8. Hechanical performance Test conditions Criterion Items A load of 20N 204 to Shall be applied Preventive 2 keys shall not be locked at strength of between adjacent keys for 15 sec. as follows. the same time. simultaneous locking Applied to the switch with simultaneous locking prevention cam. Precaution in use 1. Hote that if the load is applied to the terminals during soldering they might suffer deformation and defects in electrical performance. 2. Use of water-soluble soldering flux shall be avoided because it may cause corrosion of the switch. 3. The knob should be mounted or demounted after single-lock releasing. If attempted under single locked condition, the single-acting mechanism may be damaged. APPD. CHKD. DSGD. TITLE Sur, 30 93 DRAWING NO. PAGE SYMB DATE APPD CHKD DSGD

ALPS ELECTRIC CO., LTD.

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SPUJ-S-501 SPUJ PRODUCT SPECIFICATIONS

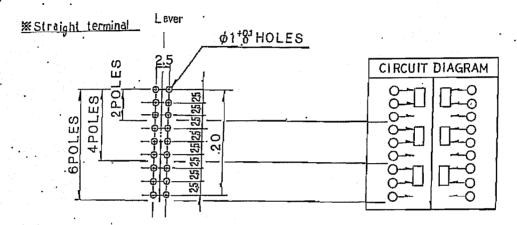
4.Flux flow .:

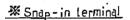
If too much flux is applied to the PCB it may penetrate into the switch and inhibit subsequent operation.

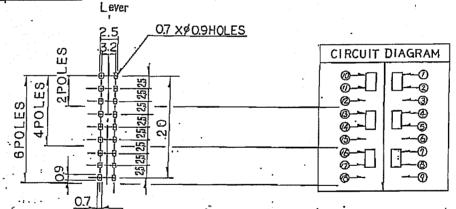


Flux may flow into the switch mount as indicated by

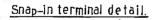
Printed circuit board mounting hole diagram . $(\pm 0.05$ tolerance unless otherwise specified)

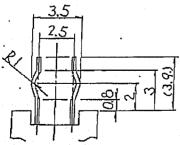






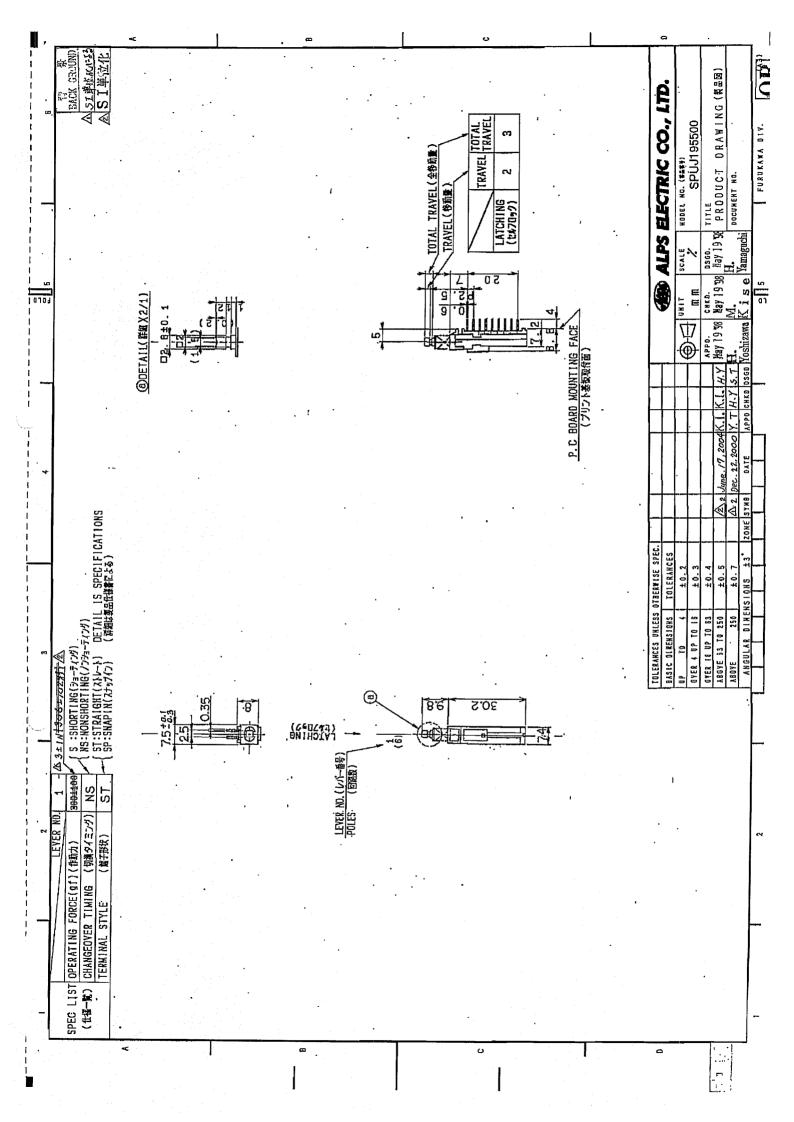
* Snap-in terminal





5 Soldering should be performed after single lock released. If attempted under single locked condition, the single-acting mechanism may be deformed by soldering heat.

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